

CGH40006P

6 W, RF Power GaN HEMT

Description

Wolfspeed's CGH40006P is an unmatched, gallium nitride (GaN) high electron mobility transistor (HEMT). The CGH40006P, operating from a 28 volt rail, offers a general purpose, broadband solution to a variety of RF and microwave applications. GaN HEMTs offer high efficiency, high gain and wide bandwidth capabilities making the CGH40006P ideal for linear and compressed amplifier circuits. The transistor is available in a solder-down, pill package.



Package Type: 440109
PN: CGH40006P

Features

- Up to 6 GHz Operation
- 13 dB Small Signal Gain at 2.0 GHz
- 11 dB Small Signal Gain at 6.0 GHz
- 8 W typical at $P_{IN} = 32$ dBm
- 28 V Operation

Applications

- 2-Way Private Radio
- Broadband Amplifiers
- Cellular Infrastructure
- Test Instrumentation
- Class A, AB, amplifiers suitable for OFDM, W-CDMA, EDGE, CDMA waveforms



Large Signal Models Available for ADS and MWO



Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V _{DSS}	120	V	25°C
Gate-to-Source Voltage	V _{GS}	-10, +2		
Storage Temperature	T _{STG}	-65, +150	°C	
Operating Junction Temperature	T _J	225		
Maximum Forward Gate Current	I _{GMAX}	2.1	mA	25°C
Maximum Drain Current ¹	I _{DMAX}	0.75	A	
Soldering Temperature ²	T _S	245	°C	
Thermal Resistance, Junction to Case ³	R _{θJC}	9.5	°C/W	85°C
Case Operating Temperature ³	T _C	-40, +150	°C	

Notes:

¹ Current limit for long term, reliable operation

² Refer to the Application Note on soldering at wolfspeed.com/rf/document-library

³ Measured for the CGH40006P at P_{DISS} = 8 W.

Electrical Characteristics (T_c = 25°C)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics¹						
Gate Threshold Voltage	V _{GS(th)}	-3.8	-3.0	-2.3	V _{DC}	V _{DS} = 10 V, I _D = 2.1 mA
Gate Quiescent Voltage	V _{GS(Q)}	—	-2.7	—		V _{DS} = 28 V, I _D = 100 mA
Saturated Drain Current	I _{DS}	1.5	2.1	—	A	V _{DS} = 6.0 V, V _{GS} = 2.0 V
Drain-Source Breakdown Voltage	V _{BR}	84	—	—	V _{DC}	V _{GS} = -8 V, I _D = 2.1 mA
RF Characteristics² (T_c = 25°C, F₀ = 2.0 GHz unless otherwise noted)						
Small Signal Gain	G _{SS}	11.5	13	—	dB	V _{DD} = 28 V, I _{DQ} = 100 mA
Power Output at P _{IN} = 32 dBm	P _{OUT}	7.0	9	—	W	
Drain Efficiency ³	η	53	65	—	%	V _{DD} = 28 V, I _{DQ} = 100 mA, P _{IN} = 32 dBm
Output Mismatch Stress	VSWR	—	—	10:1	Ψ	No damage at all phase angles, V _{DD} = 28 V, I _{DQ} = 100 mA, P _{IN} = 32 dBm
Dynamic Characteristics						
Input Capacitance	C _{GS}	—	3.0	—	pF	V _{DS} = 28 V, V _{GS} = -8 V, f = 1 MHz
Output Capacitance	C _{DS}	—	1.1	—		
Feedback Capacitance	C _{GD}	—	0.1	—		

Notes:

¹ Measured on wafer prior to packaging.

² Measured in the CGH40006P-AMP

³ Drain Efficiency = P_{OUT} / P_{DC}

Typical Performance

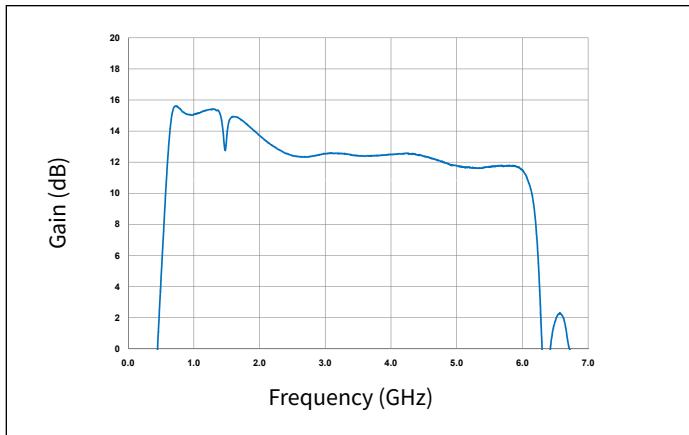


Figure 1. Small Signal Gain vs Frequency at 28 V of the CGH40006P in the CGH40006P-AMP

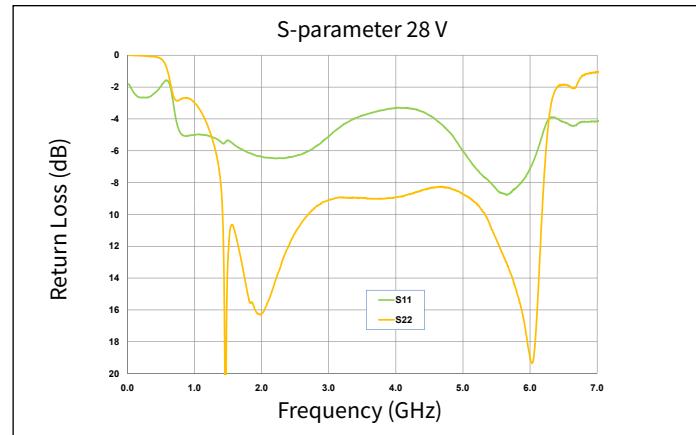


Figure 2. Input & Output Return Losses vs Frequency at 28 V of the CGH40006P in the CGH40006P-AMP

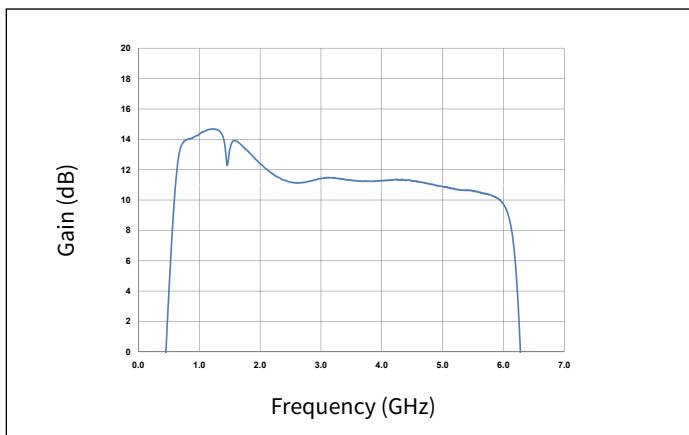


Figure 3. Small Signal Gain vs Frequency at 20 V of the CGH40006P in the CGH40006P-AMP

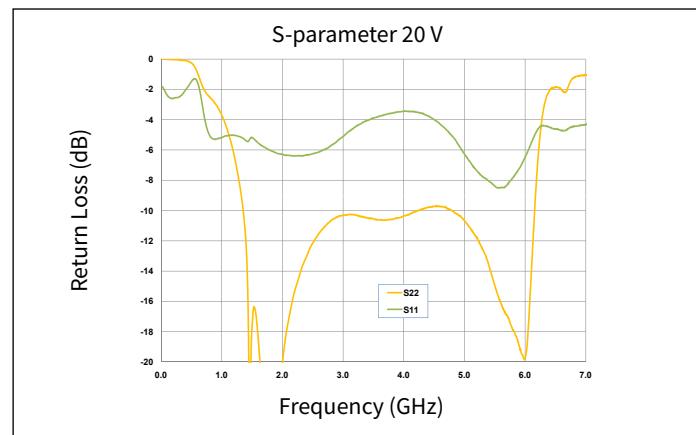


Figure 4. Input & Output Return Losses vs Frequency at 20 V of the CGH40006P in the CGH40006P-AMP

Typical Performance

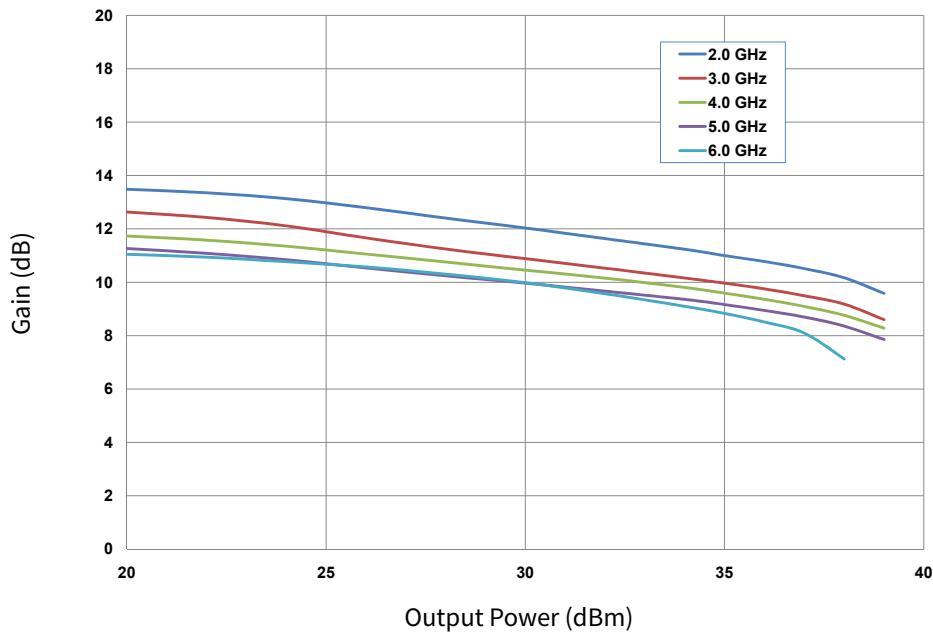


Figure 5. Power Gain vs Output Power as a Function of Frequency of the CGH40006P in the CGH40006P-AMP

$V_{DD} = 28$ V, $I_{DQ} = 100$ mA

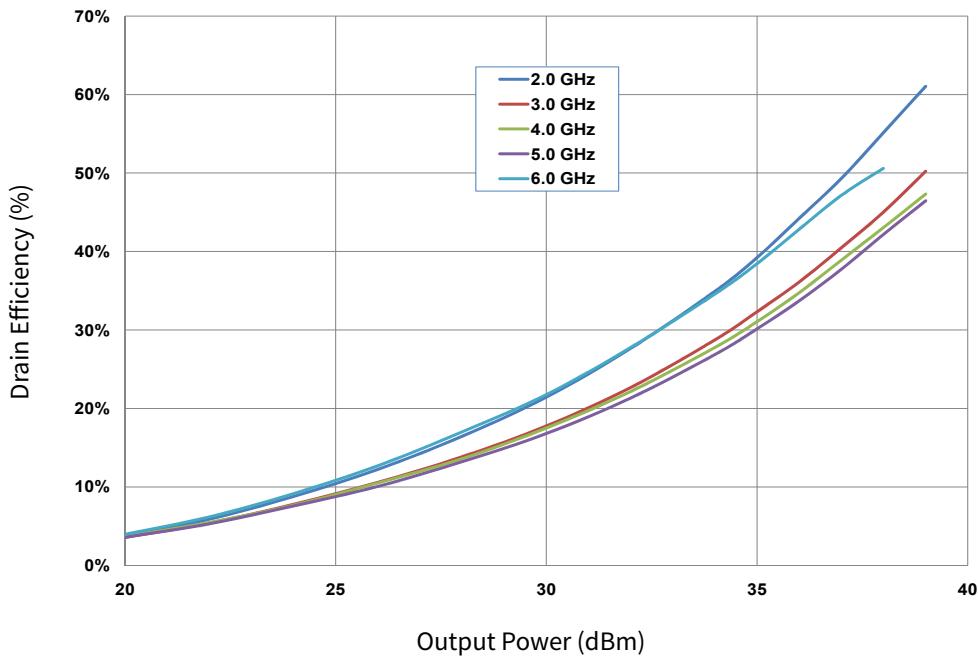


Figure 6. Drain Efficiency vs Output Power as a Function of Frequency of the CGH40006P in the CGH40006P-AMP

$V_{DD} = 28$ V, $I_{DQ} = 100$ mA

Typical Performance

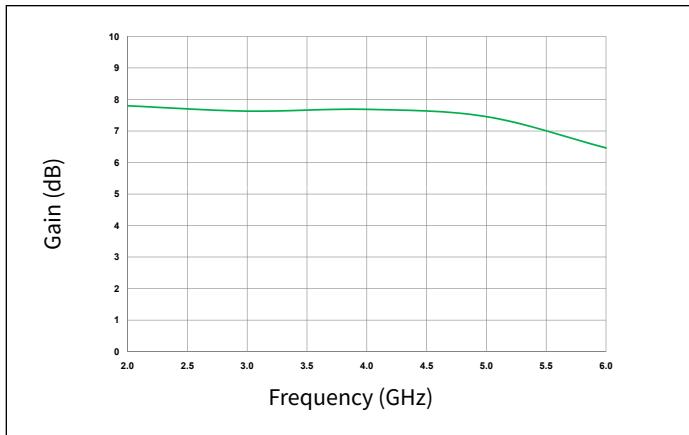


Figure 7. Small Signal Gain vs Frequency at 28 V in the CGH40006P-AMP
 $P_{IN} = 32 \text{ dBm}$, $V_{DD} = 28 \text{ V}$

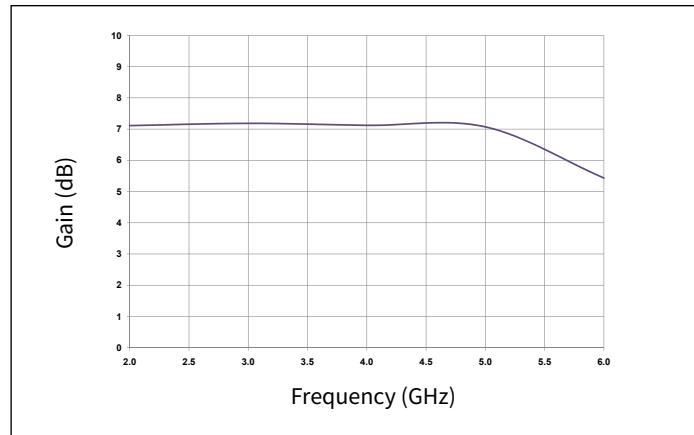


Figure 8. Power Gain vs Frequency of the CGH40006P in the CGH40006P-AMP
 $P_{IN} = 30 \text{ dBm}$, $V_{DD} = 20 \text{ V}$

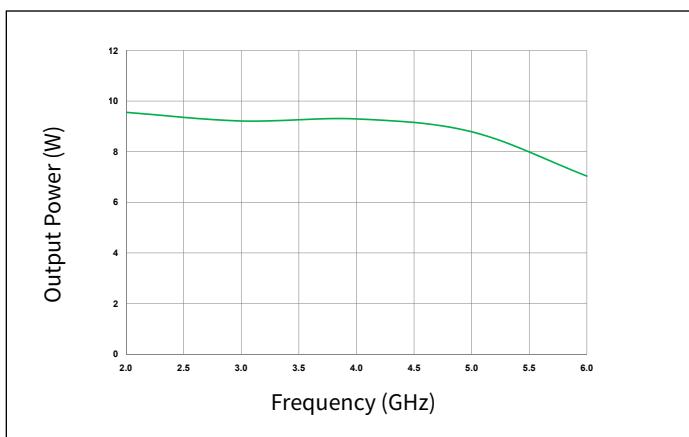


Figure 9. Output Power vs Frequency of the CGH40006P in the CGH40006P-AMP
 $P_{IN} = 32 \text{ dBm}$, $V_{DD} = 28 \text{ V}$

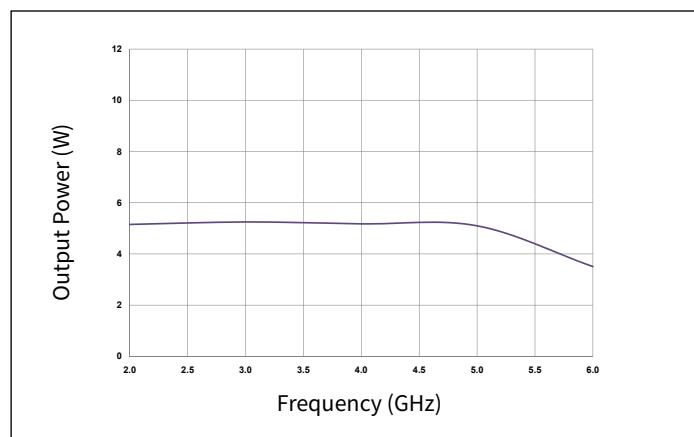


Figure 10. Output Power vs Frequency of the CGH40006P in the CGH40006P-AMP
 $P_{IN} = 30 \text{ dBm}$, $V_{DD} = 20 \text{ V}$

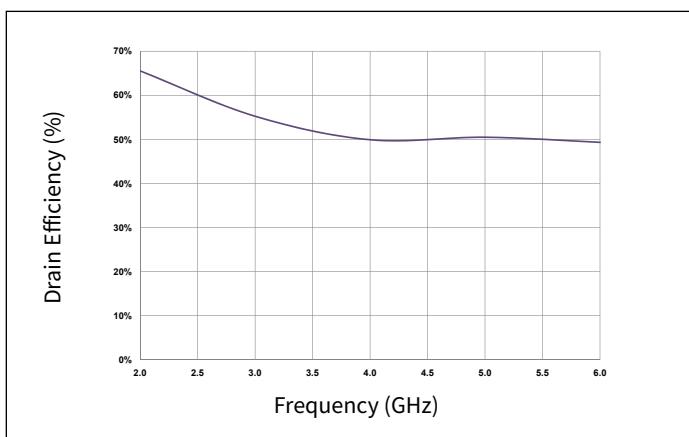


Figure 11. Drain Efficiency vs Frequency of the CGH40006P in the CGH40006P-AMP
 $P_{IN} = 32 \text{ dBm}$, $V_{DD} = 28 \text{ V}$

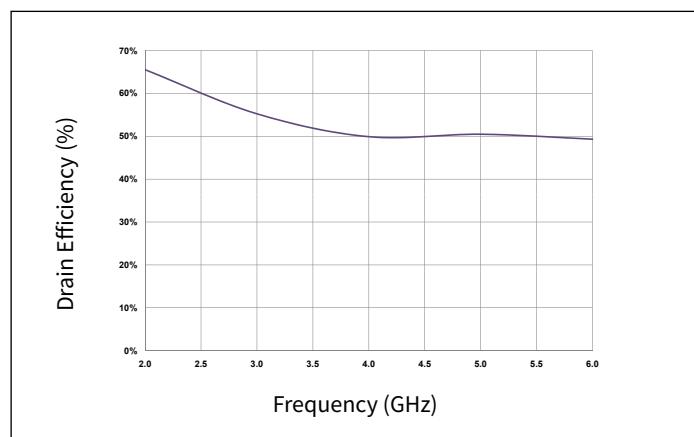


Figure 12. Drain Efficiency vs Frequency of the CGH40006P in the CGH40006P-AMP
 $P_{IN} = 30 \text{ dBm}$, $V_{DD} = 20 \text{ V}$

Typical Performance

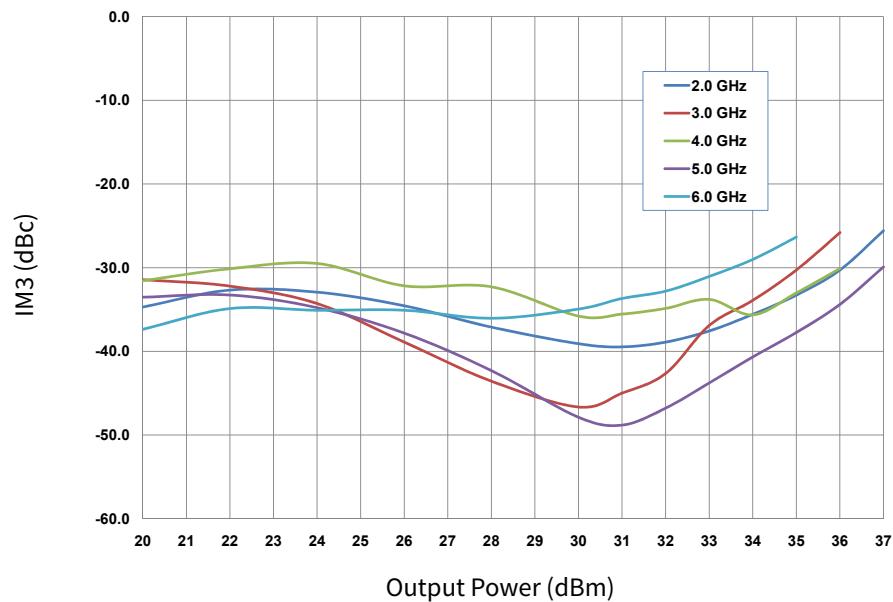


Figure 13. Third Order Intermodulation Distortion vs Average Output Power as a Function of Frequency of the CGH40006P in the CGH40006P-AMP

$V_{DD} = 28$ V, $I_{DQ} = 60$ mA

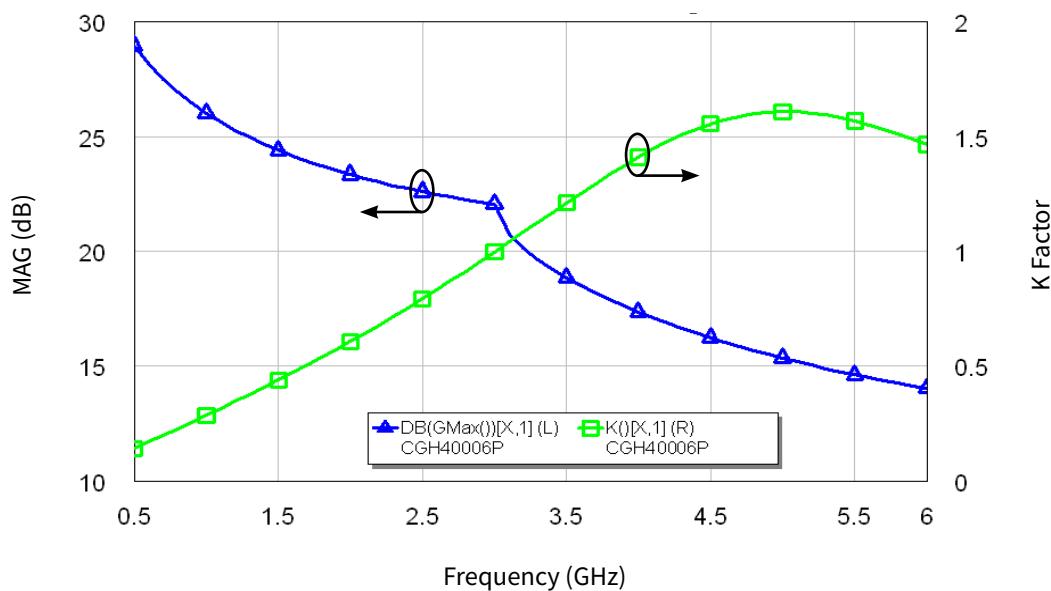


Figure 14. Simulated Maximum Available Gain and K Factor of the CGH40006P

$V_{DD} = 28$ V, $I_{DQ} = 100$ mA

Typical Noise Performance

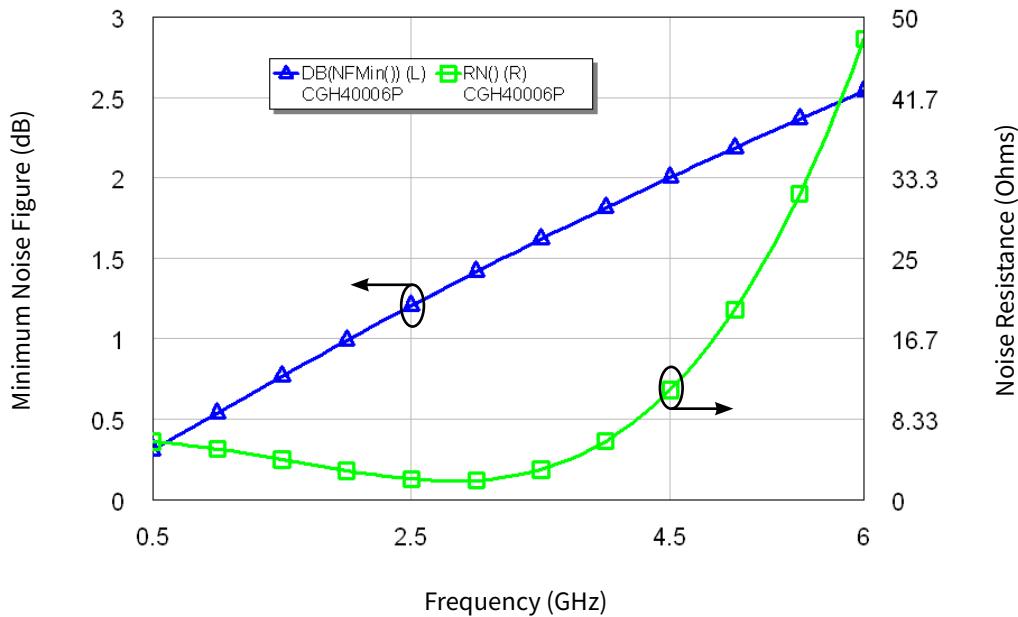


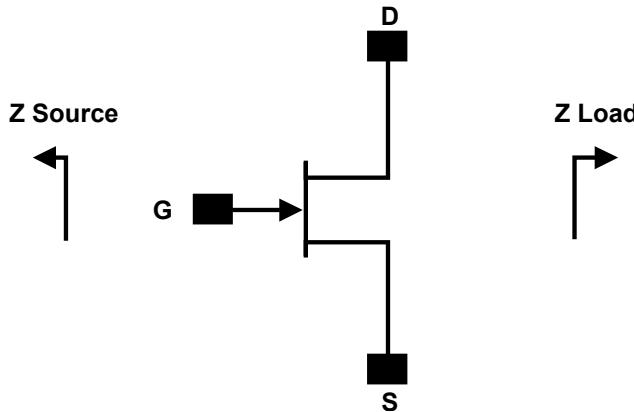
Figure 15. Simulated Minimum Noise Figure and Noise Resistance vs Frequency of the CGH40006P
 $V_{DD} = 28$ V, $I_{DQ} = 100$ mA

Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Classification Level	Test Methodology
Human Body Model	HBM	1B	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	C3	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 C101-C



Source and Load Impedances



Frequency (MHz)	Z_{Source}	Z_{Load}
1000	$13.78 + j6.9$	$61.5 + j47.4$
2000	$4.78 + j1.78$	$19.4 + j39.9$
3000	$2.57 - j6.94$	$12.57 + j23.1$
4000	$3.54 - j14.86$	$9.44 + j11.68$
5000	$4.42 - j25.8$	$9.78 + j4.85$
6000	$7.1 - j42.7$	$9.96 - j4.38$

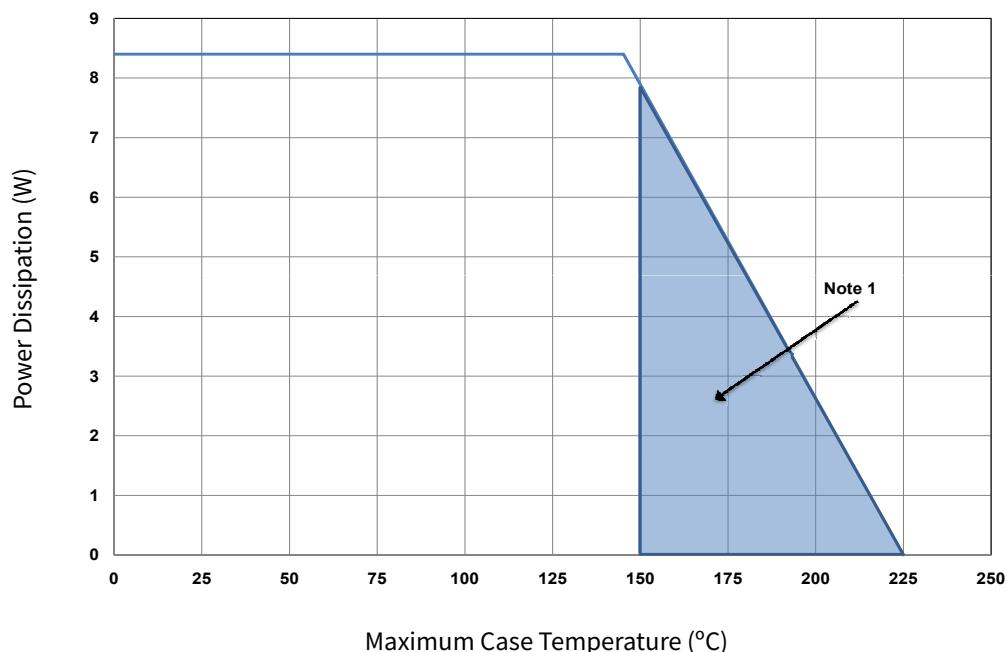
Notes:

¹ $V_{DD} = 28V$, $I_{DQ} = 100mA$ in the 440109 package

² Optimized for power gain, P_{SAT} and PAE

³ When using this device at low frequency, series resistors should be used to maintain amplifier stability

CGH40006P Power Dissipation De-rating Curve



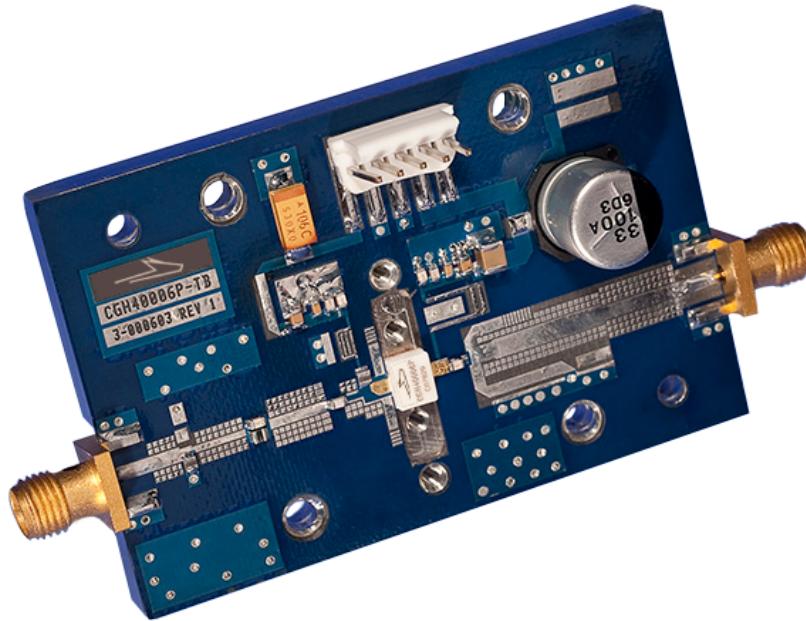
Note:

¹ Area exceeds Maximum Case Operating Temperature (See Page 2).

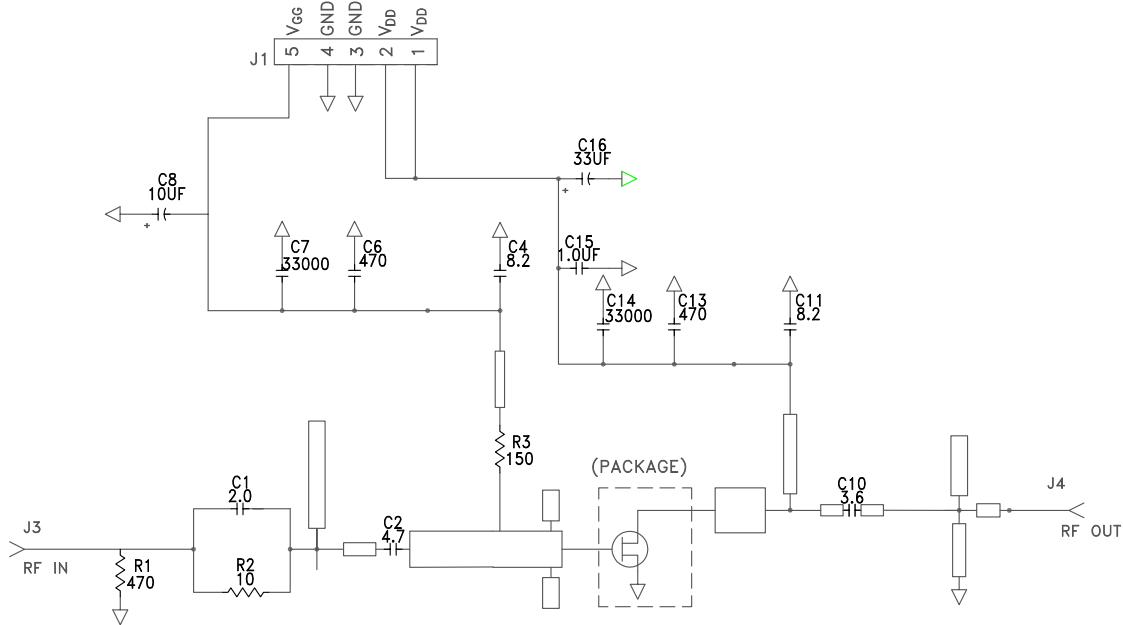
CGH40006P-AMP Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
R1	RES, AIN, 0505, 470 Ohms ($\leq 5\%$ tolerance)	1
R2	RES, AIN, 0505, 10 Ohms ($\leq 5\%$ tolerance)	1
R3	RES, AIN, 0505, 150 Ohms ($\leq 5\%$ tolerance)	1
C1	CAP, 2.0pF +/-0.1pF, 0603, ATC 600S	1
C2	CAP, 4.7pF +/-0.1pF, 0603, ATC 600S	1
C10	CAP, 3.6pF +/-0.1pF, 0603, ATC 600S	1
C4, C11	CAP, 8.2pF +/-0.25, 0603, ATC 600S	2
C6, C13	CAP, 470pF +/-5%, 0603, 100 V	2
C7, C14	CAP, 33000pF, CER, 100V, X7R, 0805	2
C8	CAP, 10 μ F, 16V, SMT, TANTALUM	1
C15	CAP, 1.0 μ F +/-10%, CER, 100V, X7R, 1210	1
C16	CAP, 33 μ F, 100V, ELECT, FK, SMD	1
J3, J4	CONN, SMA, STR, PANEL, JACK, RECP	2
J1	HEADER RT>PLZ .1CEN LK 5POS	1
-	PCB, RO5880, 20 MIL	1
Q1	CGH40006P	1

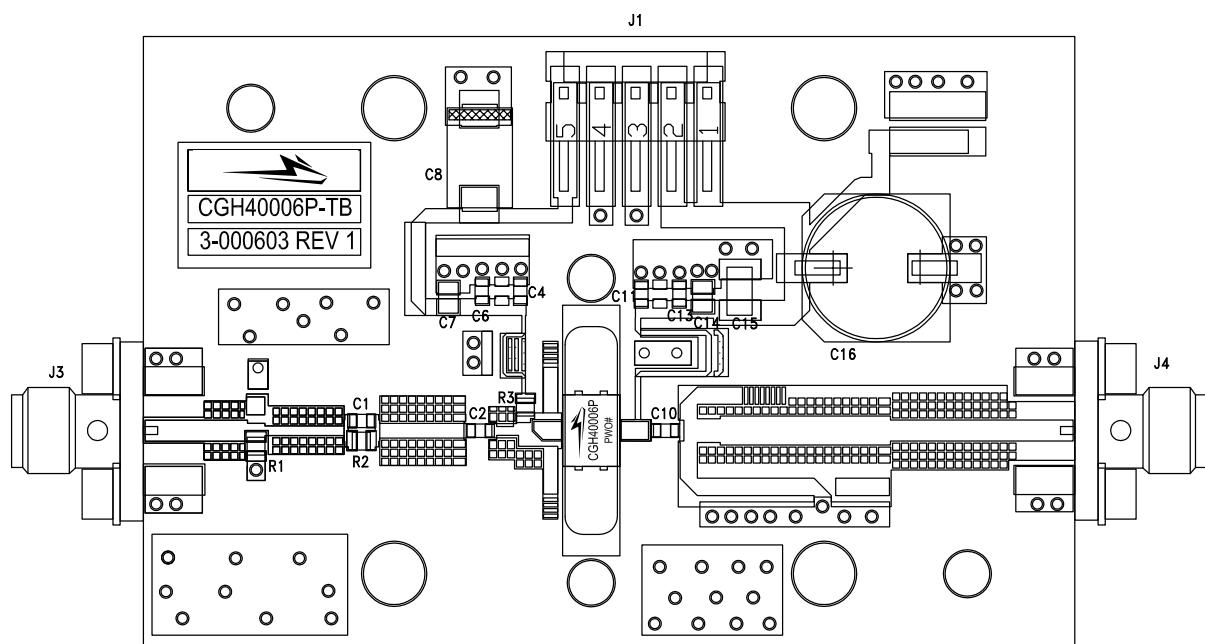
CGH40006P-AMP Demonstration Amplifier Circuit



CGH40006P-AMP Demonstration Amplifier Circuit Schematic



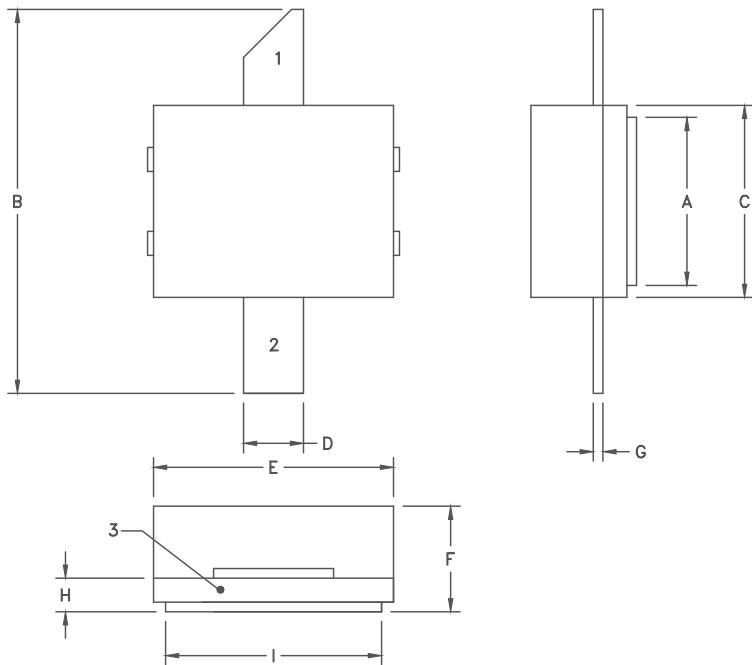
CGH40006P-AMP Demonstration Amplifier Circuit Outline



**Typical Package S-Parameters for CGH40006P
(Small Signal, $V_{DS} = 28$ V, $I_{DQ} = 100$ mA, angle in degrees)**

Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.905	-96.56	18.30	120.62	0.023	35.87	0.456	-52.76
600 MHz	0.889	-107.98	16.39	113.31	0.025	29.63	0.429	-58.98
700 MHz	0.877	-117.55	14.76	106.99	0.026	24.39	0.408	-64.31
800 MHz	0.867	-125.66	13.37	101.43	0.027	19.92	0.393	-68.96
900 MHz	0.860	-132.61	12.19	96.46	0.028	16.05	0.381	-73.11
1.0 GHz	0.854	-138.66	11.18	91.94	0.028	12.66	0.374	-76.87
1.1 GHz	0.849	-143.98	10.31	87.79	0.028	9.64	0.368	-80.34
1.2 GHz	0.845	-148.73	9.56	83.92	0.028	6.92	0.366	-83.57
1.3 GHz	0.842	-153.01	8.90	80.29	0.028	4.46	0.365	-86.61
1.4 GHz	0.839	-156.90	8.33	76.84	0.028	2.22	0.365	-89.49
1.5 GHz	0.837	-160.49	7.82	73.56	0.028	0.15	0.367	-92.24
1.6 GHz	0.835	-163.81	7.37	70.40	0.028	-1.75	0.369	-94.88
1.7 GHz	0.833	-166.92	6.96	67.36	0.028	-3.51	0.373	-97.43
1.8 GHz	0.832	-169.85	6.60	64.41	0.028	-5.15	0.376	-99.88
1.9 GHz	0.830	-172.62	6.27	61.54	0.028	-6.67	0.381	-102.27
2.0 GHz	0.829	-175.27	5.98	58.74	0.028	-8.08	0.386	-104.58
2.1 GHz	0.828	-177.81	5.71	56.00	0.028	-9.40	0.391	-106.84
2.2 GHz	0.827	179.75	5.46	53.32	0.027	-10.61	0.396	-109.04
2.3 GHz	0.826	177.38	5.24	50.68	0.027	-11.73	0.401	-111.19
2.4 GHz	0.825	175.07	5.03	48.09	0.027	-12.77	0.407	-113.29
2.5 GHz	0.824	172.82	4.84	45.53	0.027	-13.71	0.412	-115.36
2.6 GHz	0.823	170.61	4.67	43.00	0.026	-14.57	0.418	-117.38
2.7 GHz	0.821	168.44	4.51	40.50	0.026	-15.34	0.423	-119.36
2.8 GHz	0.820	166.30	4.36	38.02	0.026	-16.02	0.428	-121.32
2.9 GHz	0.819	164.18	4.22	35.57	0.026	-16.62	0.434	-123.24
3.0 GHz	0.818	162.08	4.09	33.13	0.026	-17.13	0.439	-125.13
3.2 GHz	0.816	157.91	3.85	28.31	0.025	-17.89	0.449	-128.84
3.4 GHz	0.813	153.76	3.65	23.53	0.025	-18.30	0.458	-132.46
3.6 GHz	0.810	149.58	3.47	18.78	0.025	-18.38	0.467	-136.00
3.8 GHz	0.807	145.35	3.31	14.05	0.024	-18.13	0.474	-139.48
4.0 GHz	0.804	141.05	3.18	9.32	0.024	-17.60	0.481	-142.91
4.2 GHz	0.801	136.66	3.05	4.57	0.024	-16.82	0.488	-146.30
4.4 GHz	0.797	132.15	2.94	-0.20	0.025	-15.89	0.493	-149.67
4.6 GHz	0.793	127.50	2.85	-5.01	0.025	-14.87	0.497	-153.02
4.8 GHz	0.789	122.70	2.76	-9.86	0.026	-13.89	0.500	-156.37
5.0 GHz	0.785	117.72	2.68	-14.79	0.027	-13.04	0.503	-159.74
5.2 GHz	0.780	112.55	2.62	-19.78	0.029	-12.42	0.504	-163.14
5.4 GHz	0.776	107.17	2.55	-24.86	0.030	-12.13	0.505	-166.59
5.6 GHz	0.772	101.58	2.50	-30.03	0.032	-12.22	0.504	-170.10
5.8 GHz	0.768	95.76	2.44	-35.30	0.035	-12.75	0.503	-173.70
6.0 GHz	0.764	89.70	2.40	-40.69	0.037	-13.73	0.501	-177.41

To download the s-parameters in s2p format, go to the [CGH40006P Product Page](#) and click on the documentation tab.

Product Dimensions CGH40006P (Package Type – 440109)


NOTES: (UNLESS OTHERWISE SPECIFIED)

1. INTERPRET DRAWING IN ACCORDANCE WITH ANSI Y14.5M-1982 DIMENSIONING AND TOLERANCING.
2. CONTROLLING DIMENSION: INCH.
3. ALL PLATED SURFACES ARE Ni/Au

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.135	.145	3.43	3.68
B	.315	.325	8.00	8.26
C	.155	.165	3.94	4.19
D	.045	.055	1.14	1.40
E	.195	.205	4.95	5.21
F	.085	.104	2.15	2.65
G	.007	.009	.178	0.23
H	.026	.030	.660	.762
I	.175	.185	4.45	4.70

PIN 1. GATE
PIN 2. DRAIN
PIN 3. SOURCE



Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGH40006P	GaN HEMT	Each	A close-up photograph of a GaN HEMT die. It is a rectangular, light-colored chip with gold-colored bond wires extending from its edges. Red ink printed on the die reads "CGH40006P" and "C07829".
CGH40006P-AMP	Test board with GaN HEMT installed	Each	A photograph of a blue printed circuit board (PCB) labeled "CGH40006P-AMP". The PCB features various electronic components, including resistors, capacitors, and connectors, along with the GaN HEMT die mounted on it. A small red label on the board also reads "CGH40006P-AMP".

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